## ARMSTRONG,

rman, Hattori, McLeland & Naughton

## Declaration For U.S. Patent Application

	Meciai	auon kor u.	S. Palle	THE NOTE IN THE PARTY	Calchann		
As a below name	ed inventor, I hereby deck	are that:					
My residence, po	ost ffice address and citiz	enship are as stated bel	w next to my	name.		_	
I believe I am the are listed below)	original, first and sole in of the subject matter white QUEOUS DRY LAMINATANUFACTURING METHO	ventor (if nly ne nam ch is claimed and for w re adhesive compo	e is listed belo hich a patent is STTTON FOR	w) or an origina s sought on the ARTIFICIA	al, first and joint inven invention entitled L LEATHER AND	tor (if plura	I names
the specification	ANUFACTURING METHO of which	D FOR ARTIFICIAL	LEATHER U	SING THE S.	AME.		
. (Check one	1. Zi is attached here	to.					
of blocks - 1, 2, or 3.	2. U was filed onas						
See note A	International PCT Application Serial No						
on beck of this page)	with which the second						
	3. use siled on				<b>a</b> .s		
	U.S. Application	n Serial Noed on				.•	
						200	
any amendment	t I have reviewed and undereferred to above.				•		
Regulations, § 1	e duty to disclose informat .56.						
I hereby claim for certificate listed	preign priority benefits un below and have also identi	der Title 35, United Sta fied below any foreign	ates Code, § 1 application for	19 of any fore patent or inven	ign application(s) for tor's certificate having	patent or in a filing dat	ventor's e before
that of the applic	ation for which priority is	ciained.				Priority	Claime
IT	P2000-203609	· 	Japan	05/0	07/2000	_ 🛛 Yes	
(List prior f reign	(Number)		(Country)	(Day/M	onth/Year Filed)	☐ Yes	□ No
applications.	(Number)		(Country)	(Day/N	Ionth/Year Filed)	_	
See note B on back of	(Number)		(Country)	(Day/N	Ionth/Year Filed)	_ U Yes	
this page)	(114111201)				Month/Year Filed)	_ 🗆 Yes	□ No
(See note C on b	(Number)	,	(Country)	(Day/N	ionaly rear risco)		
of this page)	□S.	ee attached list for addi	tional prior fo	reign applicatio	ns		
I hereby claim the subject matter of first paragraph of of Federal Reguldate of this appli	ne benefit under Title 35, each of the claims of this. Title 35, United States Coations, § 1.56 which occuration:	United States Code, § 1 application is not discloode, § 112, I acknowled tred between the filing of	120 of any Uni sed in the prio ige the duty to date of the prio	ited States appli r United States disclose materi or application as		nand, insoft ner provide ed in Title 3 internation	ar as the  id by the  id, Code  ial filing
(List Prior U.S. Applications)	(Applio	cation Serial Number)	(Fil	ing Date)	(Status) (patented, per	nding, aband	oned)
	(Applie	cation Serial Number)	(Fil	ing Date)	(Status) (patented, pe	nding, aband	oned)
James P. Welch, I 31.404; Mel R. C	oint as principal Attorney 32,861; John R. Pegan, R Reg. No. 17,379; Ronald I Ouintos, Reg. No. 31,898; Vivian P. Kafalenos, Reg. 5. 35,293; William L. Bro	Naughton, Reg. No. 2 Michael J. Foycik, Jr.,	4,616; Albert Reg. No. 30,92	Tockman, Reg. 28; Mary E. Go	No. 19,722; J. Herber mley, Reg. No. 34,40	rt O'Toole, l 99; James C No. 32 878:	Reg. No C. Lydon Gregor
Please direct all	communications to the fol	llowing address: A M 17 W (20	RMSTRONG CLELAND & 25 K Street, I ashington, D.( 02) 659-2930	, WESTERMA NAUGHTON J.W., Suite 100 C. 20006 Fax: (202) 887	N, HATTORI, 20 2-0357		
believed to be tru	that all statements made he; and further that these she or imprisonment, or bouldity of the application o	th, under Title 18, the stranger any patent issued ther	United States eon.	nd that all state dge that willful Code, § 1001 a	ments made on inforn I false statements and and that such willful f	nation and the like so the like statement	nade ar nade ar ents ma
(See note D	Full name of sole or first	t inventor <u>Eiji S</u>				June 28,	2001
on back of this page)	Inventor's signature	Eyi			:	Date	
	Residence	Osaka, Japa	<u>n</u>	1			
	Citizenship	Japan					

1060-16, Obu-cho, Kishiwada-shi, Osaka,

Post Office Address

Japan

Full name of second	joint inventor, if any Shingo Takeda	
Inventor's signature		June 29, 20
Residence		Date
Citizenship		
Post Office Address	3-15-405, Ikeura-cho 3-chome, Izumiotsu-shi, Osaka, J	apan
Full name of third io	int inventor, if any Kazunori Tanaka	
Inventor's signature	04	I
Residence		June 28, 200
Citizenship		
•	10-4-401, Hatsugano 2-chome, Izumi-shi, Osaka, Japan	
		<u> </u>
Full name of fourth io	int inventor, if anyYutaka Hashimoto	1
Inventor's signature		T 00
	Osaka, Japan	June 28, 200 Date
Citizenship	Innon	
	21-4-208, Momoyamadai 4-cho, Sakai-shi, Osaka, Japan	
1 fact	Japan Saka, Japan	
Part of the state		· · ·
Fuff name of fifth joint	inventor, if any	<u> </u>
Residence		Date
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